



AO3402, AO3402L (Green Product) N-Channel Enhancement Mode Field Effect Transistor

General Description

The AO3402 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. AO3402L(Green Product) is offered in a lead-free package.

Features

 $V_{DS}(V) = 30V$

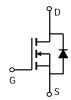
 $I_D = 4 A$

 $R_{DS(ON)}$ < 55m Ω (V_{GS} = 10V)

 $R_{DS(ON)}$ < 70m Ω (V_{GS} = 4.5V)

 $R_{DS(ON)}$ < 110m Ω (V_{GS} = 2.5V)





| Absolute Maximum Ratings T _A =25°C unless otherwise noted | | | | | | | |
|--|----------------------|-----------------------------------|------------|-------|--|--|--|
| Parameter | | Symbol | Maximum | Units | | | |
| Drain-Source Voltage | | V _{DS} | 30 | V | | | |
| Gate-Source Voltage | | V_{GS} | ±12 | V | | | |
| Continuous Drain | T _A =25°C | | 4 | | | | |
| Current ^A | T _A =70°C | I _D | 3.4 | Α | | | |
| Pulsed Drain Current ^B | | I _{DM} | 15 | | | | |
| | T _A =25°C | P_D | 1.4 | W | | | |
| Power Dissipation A | T _A =70°C | l D | 1 | VV | | | |
| Junction and Storage Temperature Range | | T _J , T _{STG} | -55 to 150 | °C | | | |

| Thermal Characteristics | | | | | | | |
|---------------------------------------|--------------|-------------------|---------|-----|-------|--|--|
| Parameter | | Symbol | Тур Мах | | Units | | |
| Maximum Junction-to-Ambient A | t ≤ 10s | $R_{	hetaJA}$ | 70 | 90 | °C/W | | |
| Maximum Junction-to-Ambient A | Steady-State | Γ _θ JA | 100 | 125 | °C/W | | |
| Maximum Junction-to-Lead ^C | Steady-State | $R_{	heta JL}$ | 63 | 80 | °C/W | | |

Electrical Characteristics (T_J=25°C unless otherwise noted)

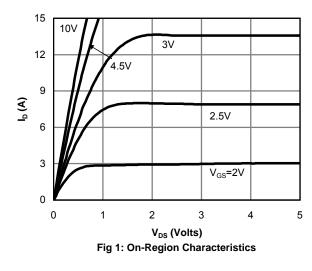
| Symbol | Parameter | Conditions | | Min | Тур | Max | Units | | |
|------------------------|--|--|-----------------------|-----|------|-----|-------|--|--|
| STATIC PARAMETERS | | | | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V$ | | 30 | | | V | | |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =24V, V _{GS} =0V | | | | 1 | ^ | | |
| | | | T _J =55°C | | | 5 | μА | | |
| I_{GSS} | Gate-Body leakage current | V _{DS} =0V, V _{GS} =±12V | | | | 100 | nA | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS} I_{D}=250\mu A$ | | 0.6 | 1 | 1.4 | V | | |
| $I_{D(ON)}$ | On state drain current | V _{GS} =4.5V, V _{DS} =5V | | 10 | | | Α | | |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} =10V, I _D =4A | | | 45 | 55 | mΩ | | |
| | | | T _J =125°C | | 66 | 80 | 11122 | | |
| | Static Dialii-Source Off-Nesistance | V_{GS} =4.5V, I_D =3A | | | 55 | 70 | mΩ | | |
| | | V_{GS} =2.5V, I_D =2A | | 83 | 110 | mΩ | | | |
| g _{FS} | Forward Transconductance | V_{DS} =5V, I_{D} =4A | | | 8 | | S | | |
| V_{SD} | Diode Forward Voltage | $I_S=1A, V_{GS}=0V$ | | | 0.8 | 1 | V | | |
| Is | Maximum Body-Diode Continuous Current | | | | | 2.5 | Α | | |
| DYNAMIC | PARAMETERS | | | | | | | | |
| C _{iss} | Input Capacitance | V _{GS} =0V, V _{DS} =15V, f=1MHz | | | 390 | | pF | | |
| C _{oss} | Output Capacitance | | | | 54.5 | | pF | | |
| C _{rss} | Reverse Transfer Capacitance | | | | 41 | | pF | | |
| R_g | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1MHz | | | 3 | | Ω | | |
| SWITCHI | NG PARAMETERS | | | | | | | | |
| Q_g | Total Gate Charge | V _{GS} =4.5V, V _{DS} =15V, I _D =4A | | | 4.34 | | nC | | |
| Q_{gs} | Gate Source Charge | | | | 0.6 | | nC | | |
| Q_{gd} | Gate Drain Charge | | | | 1.38 | | nC | | |
| t _{D(on)} | Turn-On DelayTime | | | | 3.3 | | ns | | |
| t _r | Turn-On Rise Time | V_{GS} =10V, V_{DS} =15V, R_L =3.75 Ω , R_{GEN} =6 Ω | | | 1 | | ns | | |
| t _{D(off)} | Turn-Off DelayTime | | | | 21.7 | | ns | | |
| t _f | Turn-Off Fall Time | | | | 2.1 | | ns | | |
| t _{rr} | Body Diode Reverse Recovery Time | I _F =4A, dI/dt=100A/μs | | | 12 | | ns | | |
| Q _{rr} | Body Diode Reverse Recovery Charge I _F =4A, dI/dt=100A/μs | | | 6.3 | | nC | | | |

A: The value of $R_{\theta,JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any a given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

- B: Repetitive rating, pulse width limited by junction temperature.
- C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.
- D. The static characteristics in Figures 1 to 6,12,14 are obtained using $80\mu s$ pulses, duty cycle 0.5% max.
- E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



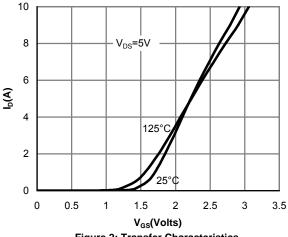


Figure 2: Transfer Characteristics

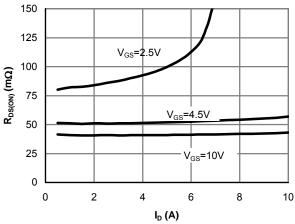


Figure 3: On-Resistance vs. Drain Current and **Gate Voltage**

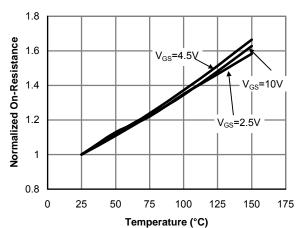


Figure 4: On-Resistance vs. Junction Temperature

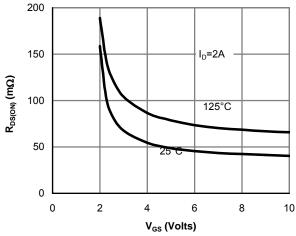


Figure 5: On-Resistance vs. Gate-Source Voltage

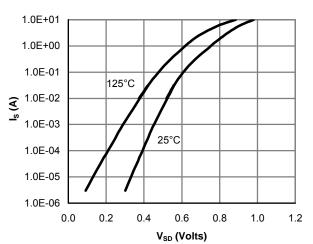


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

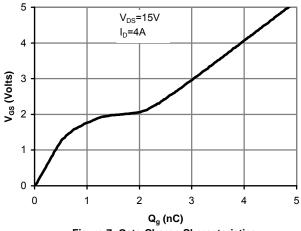


Figure 7: Gate-Charge Characteristics

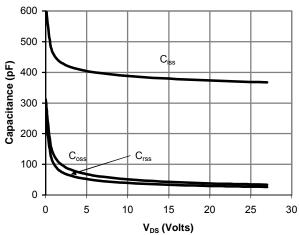


Figure 8: Capacitance Characteristics

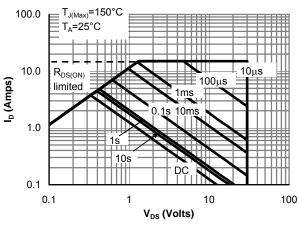


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

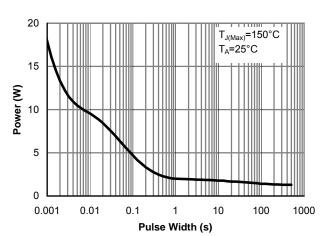


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

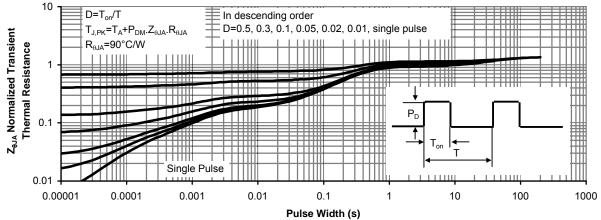


Figure 11: Normalized Maximum Transient Thermal Impedance